

February 2009

Features

- Supports AT&T TR62411 and Bellcore GR-1244-CORE and Stratum 4 timing for DS1 interfaces
- Supports ETSI ETS 300 011, TBR 4, TBR 12 and TBR 13 timing for E1 interfaces
- Selectable 19.44 MHz, 1.544 MHz, 2.048 MHz or 8kHz input reference signals
- Provides C1.5, C2, $\overline{C4}$, C6, C8, $\overline{C16}$, and C19 (STS-3/OC3 clock divided by 8) output clock signals
- Provides 5 different styles of 8 KHz framing pulses
- Attenuates wander from 1.9 Hz
- Fast lock mode
- JTAG Boundary Scan

Applications

- Synchronization and timing control for multitrunk T1 and E1 systems
- ST-BUS clock and frame pulse source

Ordering Information

MT9040AN	48 Pin SSOP	Tubes
MT9040ANR	48 Pin SSOP	Tape & Reel
MT9040AN1	48 Pin SSOP*	Tubes
MT9040ANR1	48 Pin SSOP*	Tape & Reel

*Pb Free Matte Tin

-40°C to +85°C

Description

The MT9040 T1/E1 System Synchronizer contains a digital phase-locked loop (DPLL), which provides timing and synchronization signals for T1 and E1 primary rate transmission links.

The MT9040 generates ST-BUS clock and framing signals that are phase locked to either a 19.44 MHz, 2.048 MHz, 1.544 MHz, or 8 kHz input reference.

The MT9040 is compliant with AT&T TR62411 and Bellcore GR-1244-CORE, Stratum 4; and ETSI ETS 300 011. It will meet the jitter/wander tolerance, jitter transfer, intrinsic jitter, frequency accuracy and capture range for these specifications.

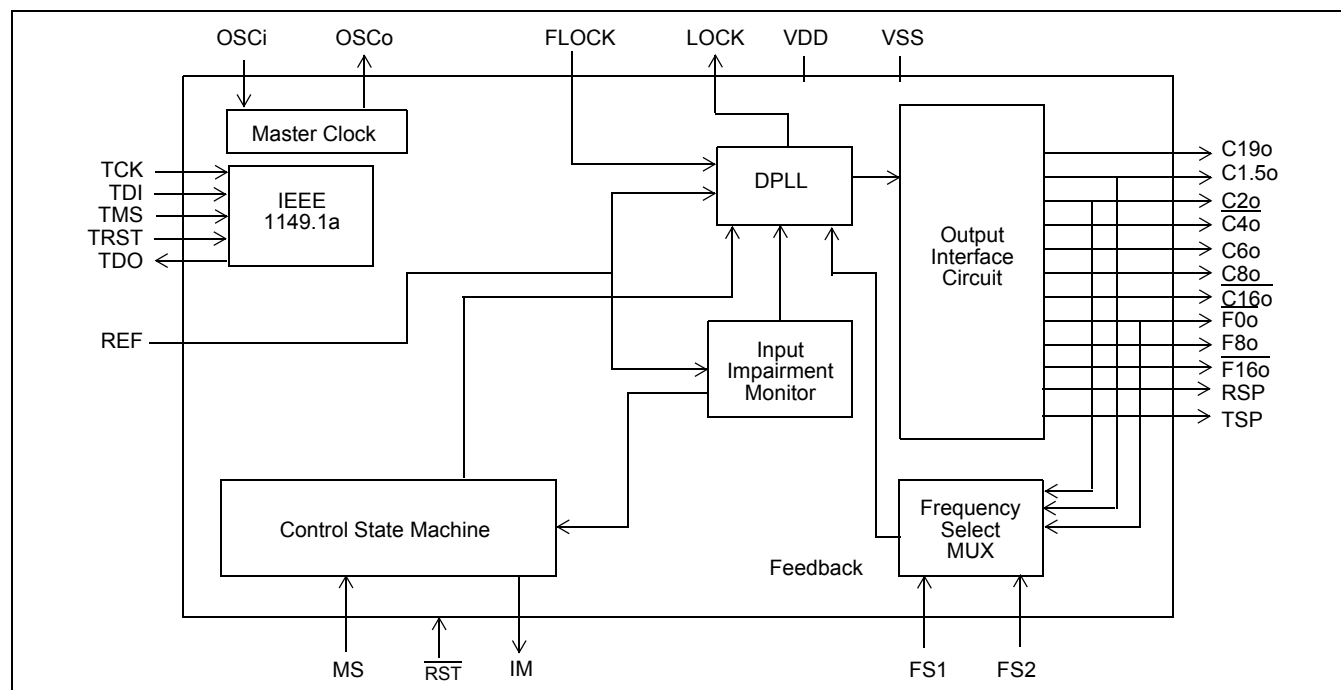


Figure 1 - Functional Block Diagram

**Zarlink Semiconductor US Patent No. 5,602,884, UK Patent No. 0772912,
 France Brevete S.G.D.G. 0772912; Germany DBP No. 69502724.7-08**

Change Summary

Changes from February 2005 Issue to February 2009 Issue.

Page	Item	Change
12	Lock Indicator	Corrected the Lock Indicator description.

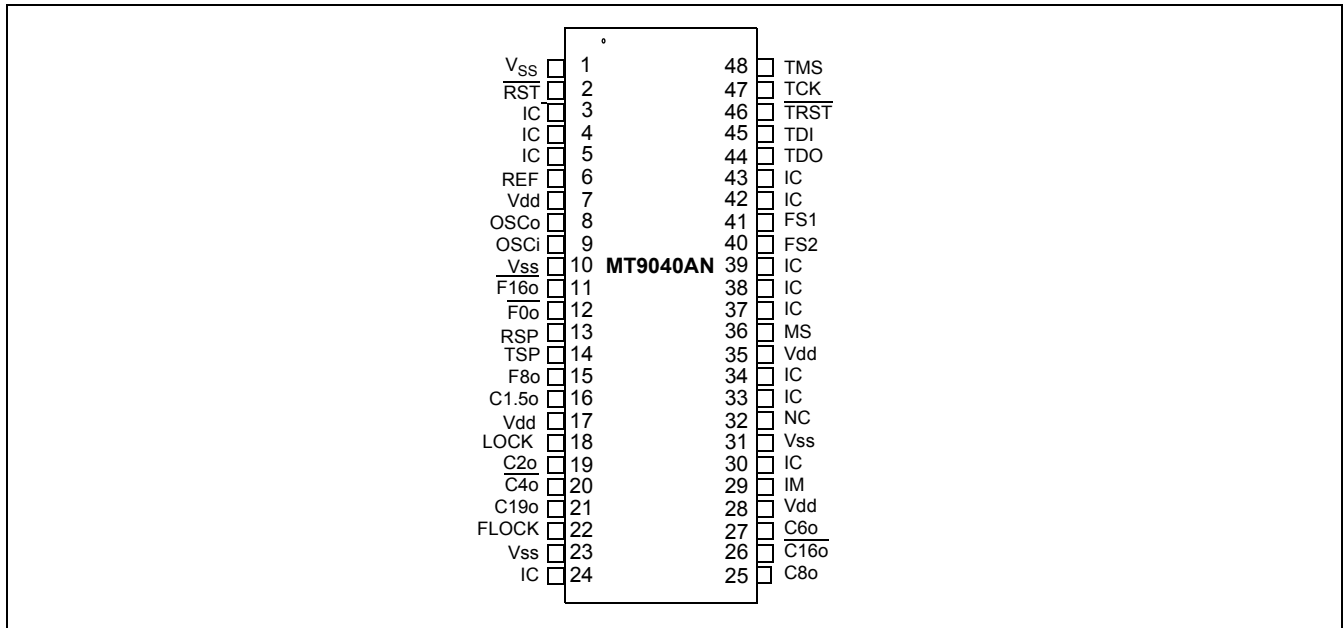


Figure 2 - Pin Connections

Pin Description

Pin #	Name	Description
1,10, 23,31	V _{SS}	Ground. 0 Volts. (V _{SS} pads).
2	RST	Reset (Input). A logic low at this input resets the MT9040. To ensure proper operation, the device must be reset after reference signal frequency changes and power-up. The RST pin should be held low for a minimum of 300 ns. While the RST pin is low, all frame pulses except RST and TSP and all clock outputs except C6o, C16o and C19o are at logic high. The RST, TSP, C6o and C16o are at logic low during reset. The C19o is free-running during reset. Following a reset, the input reference source and output clocks and frame pulses are phase aligned as shown in Figure 9.
3,4,5, 38,43	IC	Internal Connection. Leave open circuit.
6	REF	Reference (Input). This is the input reference source (falling edge) used for synchronization. One of four possible frequencies (8 kHz, 1.544 MHz, 2.048 MHz or 19.44 MHz) may be used.
7,17 28,35	V _{DD}	Positive Supply Voltage. +3.3V _{DC} nominal.

Pin Description (continued)

Pin #	Name	Description
8	OSCo	Oscillator Master Clock (CMOS Output). For crystal operation, a 20 MHz crystal is connected from this pin to OSCi, see Figure 6. Not suitable for driving other devices. For clock oscillator operation, this pin is left unconnected, see Figure 5.
9	OSCi	Oscillator Master Clock (CMOS Input). For crystal operation, a 20 MHz crystal is connected from this pin to OSCo, see Figure 6. For clock oscillator operation, this pin is connected to a clock source, see Figure 5.
11	$\overline{F16o}$	Frame Pulse ST-BUS 8.192 Mb/s (CMOS Output). This is an 8 kHz 61 ns active low framing pulse, which marks the beginning of an ST-BUS frame. This is typically used for ST-BUS operation at 8.192 Mb/s. See Figure 11.
12	$\overline{F0o}$	Frame Pulse ST-BUS 2.048 Mb/s (CMOS Output). This is an 8 kHz 244 ns active low framing pulse, which marks the beginning of an ST-BUS frame. This is typically used for ST-BUS operation at 2.048 Mb/s and 4.096 Mb/s. See Figure 11.
13	RSP	Receive Sync Pulse (CMOS Output). This is an 8 kHz 488 ns active high framing pulse, which marks the beginning of an ST-BUS frame. This is typically used for connection to the Siemens MUNICH-32 device. See Figure 12.
14	TSP	Transmit Sync Pulse (CMOS Output). This is an 8 kHz 488 ns active high framing pulse, which marks the beginning of an ST-BUS frame. This is typically used for connection to the Siemens MUNICH-32 device. See Figure 12.
15	F8o	Frame Pulse (CMOS Output). This is an 8 kHz 122 ns active high framing pulse, which marks the beginning of a frame. See Figure 11.
16	C1.5o	Clock 1.544 MHz (CMOS Output). This output is used in T1 applications.
18	LOCK	Lock Indicator (CMOS Output). This output goes high when the PLL is frequency locked to the input reference.
19	C2o	Clock 2.048 MHz (CMOS Output). This output is used for ST-BUS operation at 2.048 Mb/s.
20	$\overline{C4o}$	Clock 4.096 MHz (CMOS Output). This output is used for ST-BUS operation at 2.048 Mb/s and 4.096 Mb/s.
21	C19o	Clock 19.44 MHz (CMOS Output). This output is used in OC3/STS3 applications.
22	FLOCK	Fast Lock Mode (Input). Set high to allow the PLL to quickly lock to the input reference (less than 500 ms locking time).
24	IC	Internal Connection. Tie low for normal operation.
25	C8o	Clock 8.192 MHz (CMOS Output). This output is used for ST-BUS operation at 8.192 Mb/s.
26	$\overline{C16o}$	Clock 16.384 MHz (CMOS Output). This output is used for ST-BUS operation with a 16.384 MHz clock.
27	C6o	Clock 6.312 Mhz (CMOS Output). This output is used for DS2 applications.
29	IM	Impairment Monitor (CMOS Output). A logic high on this pin indicates that the Input Impairment Monitor has automatically put the device into Freerun Mode.
30	IC	Internal Connection. Tie high for normal operation.
32	NC	No Connection. Leave open circuit.
33,34, 42	IC	Internal Connection. Tie low for normal operation.

Pin Description (continued)

Pin #	Name	Description
36	MS	Mode/Control Select (Input). This input determines the state (Normal or Freerun) of operation. The logic level at this input is gated in by the rising edge of F8o. See Table 2.
37, 39	IC	Internal Connection. Tie low for normal operation.
40	FS2	Frequency Select 2 (Input). This input, in conjunction with FS1, selects which of four possible frequencies (8 kHz, 1.544 MHz, 2.048 MHz or 19.44 MHz) may be input to the REF input. See Table 1.
41	FS1	Frequency Select 1 (Input). See pin description for FS2.
44	TDO	Test Serial Data Out (CMOS Output). JTAG serial data is output on this pin on the falling edge of TCK. This pin is held in high impedance state when JTAG scan is not enabled.
45	TDI	Test Serial Data In (Input). JTAG serial test instructions and data are shifted in on this pin. This pin is internally pulled up to V_{DD} .
46	$\overline{\text{TRST}}$	Test Reset (Input). Asynchronously initializes the JTAG TAP controller by putting it in the Test-Logic-Reset state. If not used, this pin should be held low.
47	TCK	Test Clock (Input). Provides the clock to the JTAG test logic.
48	TMS	Test Mode Select (Input). JTAG signal that controls the state transitions of the TAP controller.

Functional Description

The MT9040 is a T1/E1 Trunk Synchronizer, providing timing (clock) and synchronization (frame) signals to interface circuits for T1 and E1 Primary Rate Digital Transmission links. Figure 1 is a functional block diagram which is described in the following sections.

Frequency Select MUX Circuit

The MT9040 operates on the falling edge of the reference. It operates with one of four possible input reference frequencies (8 kHz, 1.544 MHz, 2.048 MHz or 19.44 MHz). The frequency select inputs (FS1 and FS2) determine which of the four frequencies may be used at the reference input. A reset ($\overline{\text{RST}}$) must be performed after every frequency select input change. See Table 1.

FS2	FS1	Input Frequency
0	0	19.44 MHz
0	1	8 kHz
1	0	1.544 MHz
1	1	2.048 MHz

Table 1 - Input Frequency Selection**Digital Phase Lock Loop (DPLL)**

As shown in Figure 3, the DPLL of the MT9040 consists of a Phase Detector, Loop Filter, Digitally Controlled Oscillator and a Control Circuit.

Phase Detector - the Phase Detector compares the reference signal with the feedback signal from the Frequency Select MUX circuit, and provides an error signal corresponding to the phase difference between the two. This error signal is passed to the Loop Filter. The Frequency Select MUX allows the proper feedback signal to be externally selected (e.g., 8 kHz, 1.544 MHz, 2.048 MHz or 19.44 MHz).

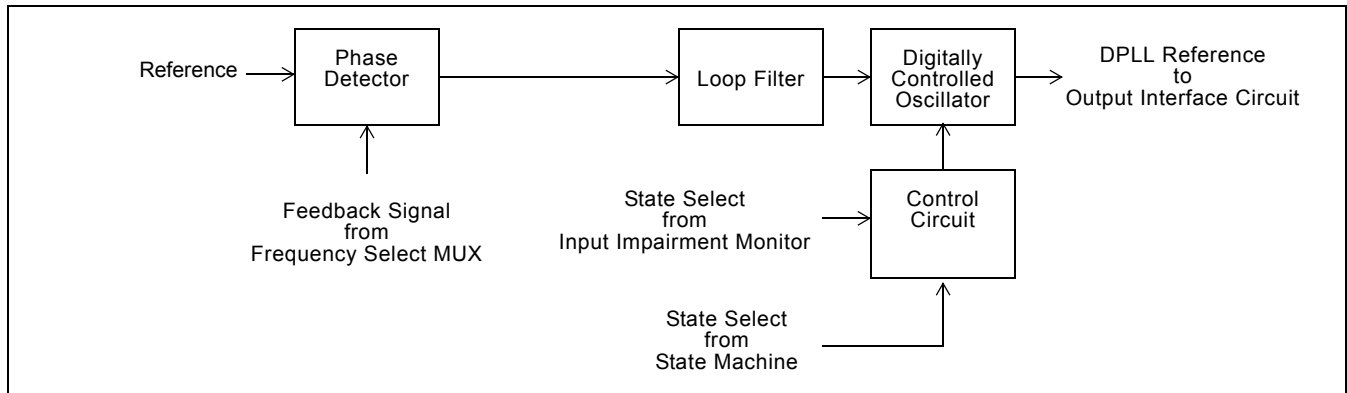


Figure 3 - DPLL Block Diagram

Loop Filter - the Loop Filter is similar to a first order low pass filter with a 1.9 Hz cutoff frequency for all four reference frequency selections (8 kHz, 1.544 MHz, 2.048 MHz or 19.44 MHz). This filter ensures that the network jitter transfer requirements are met.

Control Circuit - the Control Circuit uses status and control information from the State Machine and the Input Impairment Circuit to set the mode of the DPLL. The two possible modes are Normal and Freerun.

Digitally Controlled Oscillator (DCO) - the DCO receives the filtered signal from the Loop Filter, and based on its value, generates a corresponding digital output signal. The synchronization method of the DCO is dependent on the state of the MT9040.

In Normal Mode, the DCO provides an output signal which is frequency and phase locked to the input reference signal.

In Freerun Mode, the DCO is free running with an accuracy equal to the accuracy of the OSCi 20 MHz source.

Lock Indicator - If the PLL is in frequency lock (frequency lock means the center frequency of the PLL is identical to the line frequency), and the input phase offset is small, then the lock signal will be set high. For specific Lock Indicator design recommendations, see the Applications - Lock Indicator section.

Output Interface Circuit

The output of the DCO (DPLL) is used by the Output Interface Circuit to provide the output signals shown in Figure 4. The Output Interface Circuit uses four Tapped Delay Lines followed by a T1 Divider Circuit, an E1 Divider Circuit, and a DS2 Divider Circuit to generate the required output signals.

Four tapped delay lines are used to generate 16.384 MHz, 12.352 MHz, 12.624 MHz and 19.44 MHz signals.

The E1 Divider Circuit uses the 16.384 MHz signal to generate four clock outputs and five frame pulse outputs. The C8o, C4o and C2o clocks are generated by simply dividing the C16o clock by two, four and eight respectively. These outputs have a nominal 50% duty cycle.

The T1 Divider Circuit uses the 12.384 MHz signal to generate the C1.5o clock by dividing the internal C12 clock by eight. This output has a nominal 50% duty cycle.

The DS2 Divider Circuit uses the 12.624 MHz signal to generate the clock output C6o. This output has a nominal 50% duty cycle.

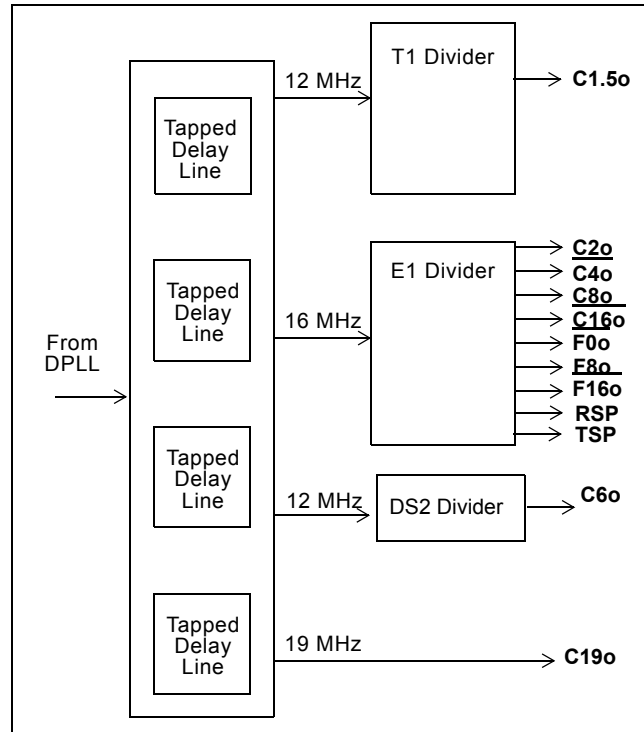


Figure 4 - Output Interface Circuit Block Diagram

The frame pulse outputs ($\overline{F0o}$, $\overline{F8o}$, $\overline{F16o}$, TSP, and RSP) are generated directly from the C16 clock.

The T1 and E1 signals are generated from a common DPLL signal. Consequently, all frame pulse and clock outputs are locked to one another for all operating states, and are also locked to the input reference in Normal Mode. See Figures 10, 11 and 12.

All frame pulse and clock outputs have limited driving capability, and should be buffered when driving high capacitance (e.g., 30 pF) loads.

Input Impairment Monitor

This circuit monitors the input signal to the DPLL for a complete loss of incoming signal, or a large frequency shift in the incoming signal. If the input signal is outside the Impairment Monitor Capture Range the PLL automatically changes from Normal Mode to Free Run Mode. See AC Electrical Characteristics - Performance for the Impairment Monitor Capture Range. When the incoming signal returns to normal, the DPLL is returned to Normal Mode.

Master Clock

The MT9040 can use either a clock or crystal as the master timing source. For recommended master timing circuits, see the Applications - Master Clock section.

Control and Mode of Operation

The MT9040 has two possible modes of operation, Normal and Freerun. As shown in Table 2, the Mode/Control Select pin MS selects the mode.

MS	Mode
0	NORMAL
1	FREERUN

Table 2 - Operating Modes and States

Normal Mode

Normal Mode is typically used when a slave clock source, synchronized to the network is required.

In Normal Mode, the MT9040 provides timing (C1.5o, C2o, $\overline{\text{C4o}}$, C8o, $\overline{\text{C16o}}$ and C19o) and frame synchronization ($\overline{\text{F0o}}$, F8o, $\overline{\text{F16o}}$, TSP and RSP) signals, which are synchronized to the reference input. The input reference signal may have a nominal frequency of 8 kHz, 1.544 MHz, 2.048 MHz or 19.44 MHz.

From a reset condition, the MT9040 will take up to 30 seconds (see AC Electrical Characteristics) of input reference signal to output signals which are synchronized (phase locked) to the reference input.

The reference frequencies are selected by the frequency control pins FS2 and FS1 as shown in Table 1.

Fast Lock Mode

Fast Lock Mode is a submode of Normal Mode, it is used to allow the MT9040 to lock to a reference more quickly than Normal mode will allow. Typically, the PLL will lock to the incoming reference within 500 ms if the FLOCK pin is set high.

Freerun Mode

Freerun Mode is typically used when a master clock source is required, or immediately following system power-up before network synchronization is achieved.

In Freerun Mode, the MT9040 provides timing and synchronization signals which are based on the master clock frequency (OSC_i) only, and are not synchronized to the reference signal.

The accuracy of the output clock is equal to the accuracy of the master clock (OSC_i). So if a ± 32 ppm output clock is required, the master clock must also be ± 32 ppm. See Applications - Crystal and Clock Oscillator sections.

MT9040 Measures of Performance

The following are some synchronizer performance indicators and their corresponding definitions.

Intrinsic Jitter

Intrinsic jitter is the jitter produced by the synchronizing circuit and is measured at its output. It is measured by applying a reference signal with no jitter to the input of the device, and measuring its output jitter. Intrinsic jitter may also be measured when the device is free running by measuring the output jitter of the device. Intrinsic jitter is usually measured with various bandlimiting filters depending on the applicable standards. In the MT9040, the intrinsic Jitter is limited to less than 0.02 UI on the 2.048 MHz and 1.544 MHz clocks.

Jitter Tolerance

Jitter tolerance is a measure of the ability of a PLL to operate properly (i.e., remain in lock and or regain lock in the presence of large jitter magnitudes at various jitter frequencies) when jitter is applied to its reference. The applied jitter magnitude and jitter frequency depends on the applicable standards.

Jitter Transfer

Jitter transfer or jitter attenuation refers to the magnitude of jitter at the output of a device for a given amount of jitter at the input of the device. Input jitter is applied at various amplitudes and frequencies, and output jitter is measured with various filters depending on the applicable standards.

For the MT9040, the jitter attenuation is determined by the 1.9 Hz low pass loop filter.

The MT9040 has twelve outputs with three possible input frequencies (except for 19.44 MHz, which is internally divided to 8 KHz) for a total of 36 possible jitter transfer functions. Since all outputs are derived from the same signal, the jitter transfer values for the four cases, 8 kHz to 8 kHz, 1.544 MHz to 1.544 MHz and 2.048 MHz to 2.048 MHz can be applied to all outputs.

It should be noted that 1 UI at 1.544 MHz is 644 ns, which is not equal to 1 UI at 2.048 MHz, which is 488 ns. Consequently, a transfer value using different input and output frequencies must be calculated in common units (e.g., seconds) as shown in the following example.

What is the T1 and E1 output jitter when the T1 input jitter is 20 UI (T1 UI Units) and the T1 to T1 jitter attenuation is 18 dB?

$$\begin{aligned} \text{OutputT1} &= \text{InputT1} \times 10^{\left(\frac{-A}{20}\right)} \\ \text{OutputT1} &= 20 \times 10^{\left(\frac{-18}{20}\right)} = 2.5 \text{UI(T1)} \\ \text{OutputE1} &= \text{OutputT1} \times \frac{(1 \text{UIT1})}{(1 \text{UIE1})} \\ \text{OutputE1} &= \text{OutputT1} \times \frac{(644 \text{ns})}{(488 \text{ns})} = 3.3 \text{UI(T1)} \end{aligned}$$

Using the above method, the jitter attenuation can be calculated for all combinations of inputs and outputs based on the three jitter transfer functions provided.

Note that the resulting jitter transfer functions for all combinations of inputs (8 kHz, 1.544 MHz, 2.048 MHz) and outputs (8 kHz, 1.544 MHz, 2.048 MHz, 4.096 MHz, 8.192 MHz, 16.384 MHz, 19.44 MHz) for a given input signal (jitter frequency and jitter amplitude) are the same.

Since intrinsic jitter is always present, jitter attenuation will appear to be lower for small input jitter signals than for large ones. Consequently, accurate jitter transfer function measurements are usually made with large input jitter signals (e.g., 75% of the specified maximum jitter tolerance).

Frequency Accuracy

Frequency accuracy is defined as the absolute tolerance of an output clock signal when it is not locked to an external reference, but is operating in a free running mode. For the MT9040, the Freerun accuracy is equal to the Master Clock (OSC_i) accuracy.

Capture Range

Also referred to as pull-in range. This is the input frequency range over which the synchronizer must be able to pull into synchronization. The MT9040 capture range is equal to ± 230 ppm minus the accuracy of the master clock (OSCi). For example, a 32 ppm master clock results in a capture range of 198 ppm.

Lock Range

This is the input frequency range over which the synchronizer must be able to maintain synchronization. The lock range is equal to the capture range for the MT9040.

Phase Lock Time

This is the time it takes the synchronizer to phase lock to the input signal. Phase lock occurs when the input signal and output signal are not changing in phase with respect to each other (not including jitter).

Lock time is very difficult to determine because it is affected by many factors which include:

- initial input to output phase difference
- initial input to output frequency difference
- synchronizer loop filter

Although a short lock time is desirable, it is not always possible to achieve due to other synchronizer requirements. For instance, better jitter transfer performance is achieved with a lower frequency loop filter which increases lock time. See AC Electrical Characteristics - Performance for Maximum Phase Lock Time.

MT9040 provides a fast lock pin (FLOCK), which, when set high enables the PLL to lock to an incoming reference within approximately 500 ms.

MT9040 and Network Specifications

The MT9040 fully meets all applicable PLL requirements (intrinsic jitter, jitter/wander tolerance, jitter/wander transfer, frequency accuracy and capture range for the following specifications.

1. Bellcore GR-1244-CORE June 1995 for Stratum 4
2. AT&T TR62411(DS1) December 1990 for Stratum 4
3. ANSI T1.101 (DS1) February 1994 for Stratum 4
4. ETSI 300 011 (E1) April 1992
5. TBR 4 November 1995
6. TBR 12 December 1993
7. TBR 13 January 1996
8. ITU-T I.431 March 1993

Applications

This section contains MT9040 application specific details for clock and crystal operation, reset operation, power supply decoupling, and control operation.

Master Clock

The MT9040 can use either a clock or crystal as the master timing source.

In Freerun Mode, the frequency tolerance at the clock outputs is identical to the frequency tolerance of the source at the OSCi pin. For applications not requiring an accurate Freerun Mode, tolerance of the master timing source may be ± 100 ppm. For applications requiring an accurate Freerun Mode, such as AT&T TR62411, the tolerance of the master timing source must be no greater than ± 32 ppm.

Another consideration in determining the accuracy of the master timing source is the desired capture range. The sum of the accuracy of the master timing source and the capture range of the MT9040 will always equal 230 ppm. For example, if the master timing source is 100 ppm, then the capture range will be 130 ppm.

Clock Oscillator - when selecting a Clock Oscillator, numerous parameters must be considered. This includes absolute frequency, frequency change over temperature, output rise and fall times, output levels and duty cycle.

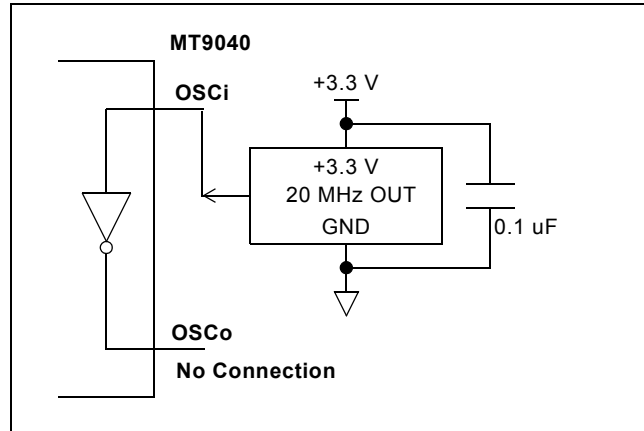


Figure 5 - Clock Oscillator Circuit

For applications requiring ± 32 ppm clock accuracy, the following clock oscillator module may be used.

FOX F7C-2E3-20.0MHz

Frequency: 20 MHz
 Tolerance: 25 ppm 0C to 70C
 Rise & Fall Time: 10 ns (0.33 V 2.97 V 15 pF)
 Duty Cycle: 40% to 60%

CTS CB3LV-5I-20.0 MHz

Frequency: 20 MHz
 Tolerance: 25 ppm
 Rise & Fall Time: 10 ns
 Duty Cycle: 45% to 55%

The output clock should be connected directly (not AC coupled) to the OSCi input of the MT9040, and the OSCo output should be left open as shown in Figure 9.

Crystal Oscillator - Alternatively, a Crystal Oscillator may be used. A complete oscillator circuit made up of a crystal, resistor and capacitors is shown in Figure 6.

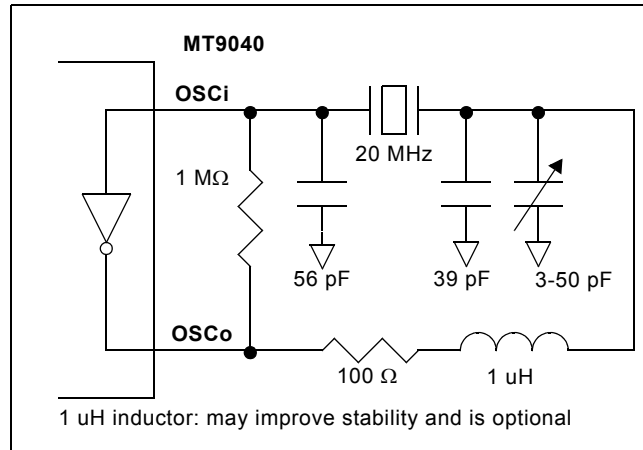


Figure 6 - Crystal Oscillator Circuit

The accuracy of a crystal oscillator depends on the crystal tolerance as well as the load capacitance tolerance. Typically, for a 20 MHz crystal specified with a 32 pF load capacitance, each 1 pF change in load capacitance contributes approximately 9 ppm to the frequency deviation. Consequently, capacitor tolerances, and stray capacitances have a major effect on the accuracy of the oscillator frequency.

The trimmer capacitor shown in Figure 6 may be used to compensate for capacitive effects. If accuracy is not a concern, then the trimmer may be removed, the 39 pF capacitor may be increased to 56 pF, and a wider tolerance crystal may be substituted.

The crystal should be a fundamental mode type - not an overtone. The fundamental mode crystal permits a simpler oscillator circuit with no additional filter components and is less likely to generate spurious responses. The crystal specification is as follows.

<i>Frequency:</i>	<i>20 MHz</i>
<i>Tolerance:</i>	<i>As required</i>
<i>Oscillation Mode:</i>	<i>Fundamental</i>
<i>Resonance Mode:</i>	<i>Parallel</i>
<i>Load Capacitance:</i>	<i>32 pF</i>
<i>Maximum Series Resistance:</i>	<i>35 Ω</i>
<i>Approximate Drive Level:</i>	<i>1 mW</i>
<i>e.g., R1B23B32-20.0MHz</i>	
<i>(20 ppm absolute, ±6 ppm 0C to 50C, 32 pF, 25 Ω)</i>	

Reset Circuit

A simple power up reset circuit with about a 50 us reset low time is shown in Figure 7. Resistor R_P is for protection only and limits current into the $\overline{\text{RST}}$ pin during power down conditions. The reset low time is not critical but should be greater than 300 ns.

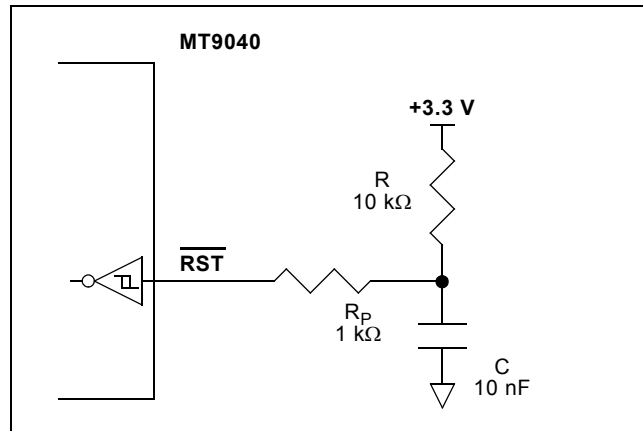


Figure 7 - Power-Up Reset Circuit

Lock Indicator

The LOCK pin toggles at a random rate when the PLL is frequency locked to the input reference. The low time totally depends on the spectral content of jitter/wander that is present on the input reference and the 20 MHz system clock of the MT9040.

If the reference clock input is within +/-100ppm, the low state on the LOCK pin would not exceed 30sec. If the LOCK state remains low for more than 30sec, it indicates that the MT9040 is not able to maintain lock to the incoming reference. In the event that the reference clock from the network is missing, the MT9040 will be in the Freerun mode.

Flock should only be use at powerup, otherwise the output clock will not meet AT&T TR62411 and Bellcore GR-1244-CORE and Stratum 4 timing standard.

Absolute Maximum Ratings* - Voltages are with respect to ground (V_{SS}) unless otherwise stated.

	Parameter	Symbol	Min.	Max.	Units
1	Supply voltage	V_{DD}	-0.3	7.0	V
2	Voltage on any pin	V_{PIN}	-0.3	$V_{DD}+0.3$	V
3	Current on any pin	I_{PIN}		30	mA
4	Storage temperature	T_{ST}	-55	125	°C
5	48 SSOP package power dissipation	P_{PD}		200	mW

* Exceeding these values may cause permanent damage. Functional operation under these conditions is not implied.

Recommended Operating Conditions - Voltages are with respect to ground (V_{SS}) unless otherwise stated.

	Characteristics	Sym.	Min.	Max.	Units
1	Supply voltage	V_{DD}	3.0	3.6	V
2	Operating temperature	T_A	-40	85	°C

DC Electrical Characteristics* - Voltages are with respect to ground (V_{SS}) unless otherwise stated.

	Characteristics	Sym.	Min.	Max.	Units	Conditions/Notes
1	Supply current with: $OSC_i = 0V$	I_{DDS}		1.8	mA	Outputs unloaded
2	$OSC_i = \text{Clock}$	I_{DD}		50	mA	Outputs unloaded
3	CMOS high-level input voltage	V_{CIH}	$0.7V_{DD}$		V	
4	CMOS low-level input voltage	V_{CIL}		$0.3V_{DD}$	V	
5	Input leakage current	I_{IL}		15	μA	$V_I = V_{DD}$ or $0V$
6	High-level output voltage	V_{OH}	2.4		V	$I_{OH} = 10 \text{ mA}$
7	Low-level output voltage	V_{OL}		0.4	V	$I_{OL} = 10 \text{ mA}$

* Supply voltage and operating temperature are as per Recommended Operating Conditions.

AC Electrical Characteristics - Performance

	Characteristics	Sym.	Min.	Max.	Units	Conditions/ Notes†
1	Freerun Mode accuracy with OSCi at: ± 0 ppm		-0	+0	ppm	4-8
2	± 32 ppm		-32	+32	ppm	4-8
3	± 100 ppm		-100	+100	ppm	4-8
4	Capture range with OSCi at: ± 0 ppm		-230	+230	ppm	1-3,5-8
5	± 32 ppm		-198	+198	ppm	1-3,5-8
6	± 100 ppm		-130	+130	ppm	1-3,5-8
7	Phase lock time			30	s	1-3,5-14
8	Impairment Monitor Capture Range at: 8 kHz, 19.44 MHz		-30k	+30k	ppm	1-3,5,8,9-11
9	1.544 MHz		-30k	+30k	ppm	1-3,6,9-11
10	2.048 MHz		-30k	+30k	ppm	1-3,7,9-11

† See "Notes" following AC Electrical Characteristics tables.

AC Electrical Characteristics - Timing Parameter Measurement Voltage Levels* - Voltages are with respect to ground (V_{SS}) unless otherwise stated

	Characteristics	Sym.	CMOS	Units
1	Threshold Voltage	V_T	$0.5V_{DD}$	V
2	Rise and Fall Threshold Voltage High	V_{HM}	$0.7V_{DD}$	V
3	Rise and Fall Threshold Voltage Low	V_{LM}	$0.3V_{DD}$	V

* Supply voltage and operating temperature are as per Recommended Operating Conditions.

* Timing for input and output signals is based on the worst case result of the CMOS thresholds.

* See Figure 9.

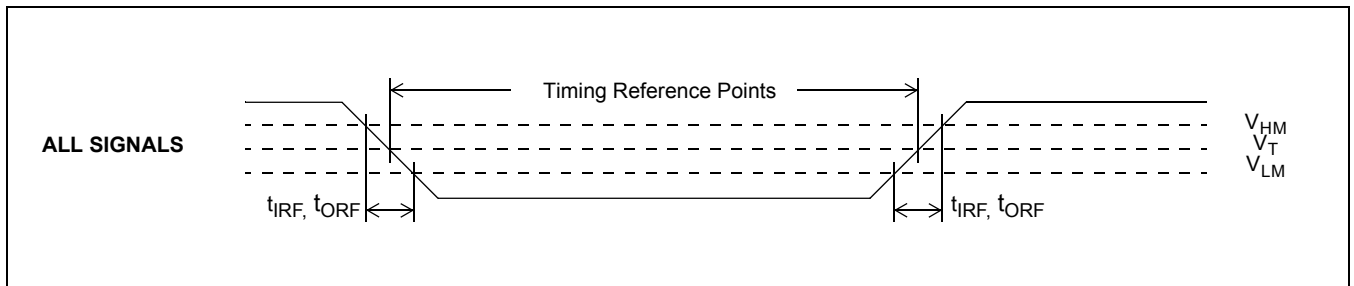


Figure 8 - Timing Parameter Measurement Voltage Levels

AC Electrical Characteristics - Input/Output Timing

	Characteristics	Sym.	Min.	Max.	Units
1	Reference input pulse width high or low	t_{RW}	100		ns
2	Reference input rise or fall time	t_{IRF}		10	ns
3	8 kHz reference input to F8o delay	t_{R8D}	-21	6	ns
4	1.544 MHz reference input to F8o delay	t_{R15D}	337	363	ns
5	2.048 MHz reference input to F8o delay	t_{R2D}	222	238	ns
6	19.44 MHz reference input to F8o delay	t_{R19D}	46	57	ns
7	F8o to $\overline{F0o}$ delay	t_{F0D}	111	130	ns
8	$\overline{F16o}$ setup to $\overline{C16o}$ falling	t_{F16S}	25	40	ns
9	$\overline{F16o}$ hold to $\overline{C16o}$ rising	t_{F16H}	-10	10	ns
10	F8o to C1.5o delay	t_{C15D}	-45	-25	ns
11	F8o to C6o delay	t_{C6D}	-10	10	ns
12	F8o to C2o delay	t_{C2D}	-11	5	ns
13	F8o to $\overline{C4o}$ delay	t_{C4D}	-11	5	ns
14	F8o to C8o delay	t_{C8D}	-11	5	ns
15	F8o to $\overline{C16o}$ delay	t_{C16D}	-11	5	ns
16	F8o to TSP delay	t_{TSPD}	-6	10	ns
17	F8o to RSP delay	t_{RSPD}	-8	8	ns
18	F8o to C19o delay	t_{C19D}	-15	5	ns
19	C1.5o pulse width high or low	t_{C15W}	309	339	ns
20	C6o pulse width high or low	t_{C6W}	70	86	ns
21	C2o pulse width high or low	t_{C2W}	230	258	ns
22	$\overline{C4o}$ pulse width high or low	t_{C4W}	111	133	ns
23	C8o pulse width high or low	t_{C8W}	52	70	ns
24	$\overline{C16o}$ pulse width high or low	t_{C16WL}	24	35	ns
25	TSP pulse width high	t_{TSPW}	478	494	ns
26	RSP pulse width high	t_{RSPW}	474	491	ns
27	C19o pulse width high	t_{C19WH}	25	35	ns
28	C19o pulse width low	t_{C19WL}	17	25	ns
29	$\overline{F0o}$ pulse width low	t_{F0WL}	234	254	ns
30	F8o pulse width high	t_{F8WH}	109	135	ns
31	$\overline{F16o}$ pulse width low	t_{F16WL}	47	75	ns
32	Output clock and frame pulse rise or fall time	t_{ORF}		9	ns
33	Input Controls Setup Time	t_S	100		ns
34	Input Controls Hold Time	t_H	100		ns

	Characteristics	Sym.	Min.	Max.	Units
1	Reference input pulse width high or low	t_{RW}	100		ns
2	Reference input rise or fall time	t_{IRF}		10	ns
3	8 kHz reference input to F8o delay	t_{R8D}	-21	6	ns
4	1.544 MHz reference input to F8o delay	t_{R15D}	337	363	ns
5	2.048 MHz reference input to F8o delay	t_{R2D}	222	238	ns
6	19.44 MHz reference input to F8o delay	t_{R19D}	46	57	ns
7	F8o to $\overline{F0o}$ delay	t_{F0D}	111	130	ns
8	$\overline{F16o}$ setup to $\overline{C16o}$ falling	t_{F16S}	25	40	ns
9	$\overline{F16o}$ hold to $\overline{C16o}$ rising	t_{F16H}	-10	10	ns
10	F8o to C1.5o delay	t_{C15D}	-45	-25	ns
11	F8o to C6o delay	t_{C6D}	-10	10	ns
12	F8o to C2o delay	t_{C2D}	-11	5	ns
13	F8o to $\overline{C4o}$ delay	t_{C4D}	-11	5	ns
14	F8o to C8o delay	t_{C8D}	-11	5	ns
15	F8o to $\overline{C16o}$ delay	t_{C16D}	-11	5	ns
16	F8o to TSP delay	t_{TSPD}	-6	10	ns
17	F8o to RSP delay	t_{RSPD}	-8	8	ns
18	F8o to C19o delay	t_{C19D}	-15	5	ns
19	C1.5o pulse width high or low	t_{C15W}	309	339	ns
20	C6o pulse width high or low	t_{C6W}	70	86	ns
21	C2o pulse width high or low	t_{C2W}	230	258	ns
22	$\overline{C4o}$ pulse width high or low	t_{C4W}	111	133	ns
23	C8o pulse width high or low	t_{C8W}	52	70	ns
24	$\overline{C16o}$ pulse width high or low	t_{C16WL}	24	35	ns
25	TSP pulse width high	t_{TSPW}	478	494	ns
26	RSP pulse width high	t_{RSPW}	474	491	ns
27	C19o pulse width high	t_{C19WH}	25	35	ns
28	C19o pulse width low	t_{C19WL}	17	25	ns
29	$\overline{F0o}$ pulse width low	t_{F0WL}	234	254	ns
30	F8o pulse width high	t_{F8WH}	109	135	ns
31	$\overline{F16o}$ pulse width low	t_{F16WL}	47	75	ns
32	Output clock and frame pulse rise or fall time	t_{ORF}		9	ns
33	Input Controls Setup Time	t_S	100		ns
34	Input Controls Hold Time	t_H	100		ns

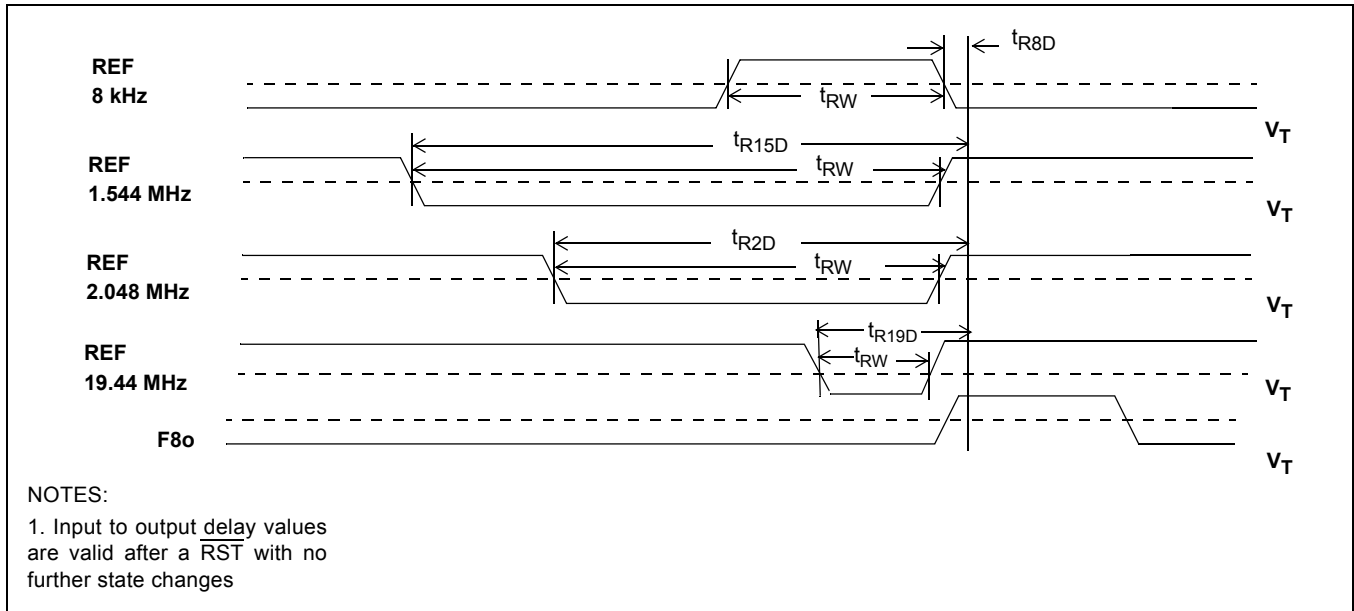


Figure 9 - Input to Output Timing (Normal Mode)

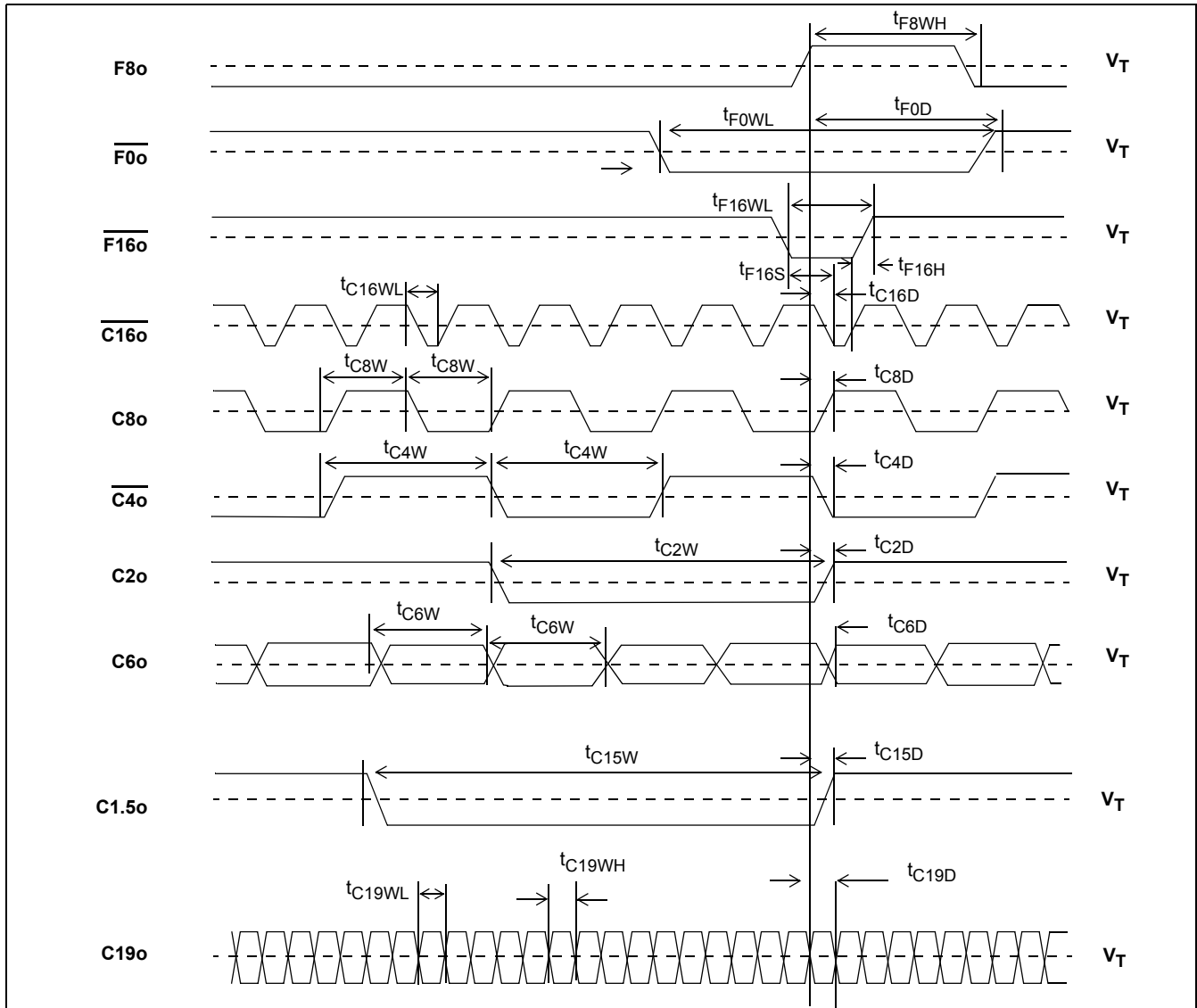


Figure 10 - Output Timing 1

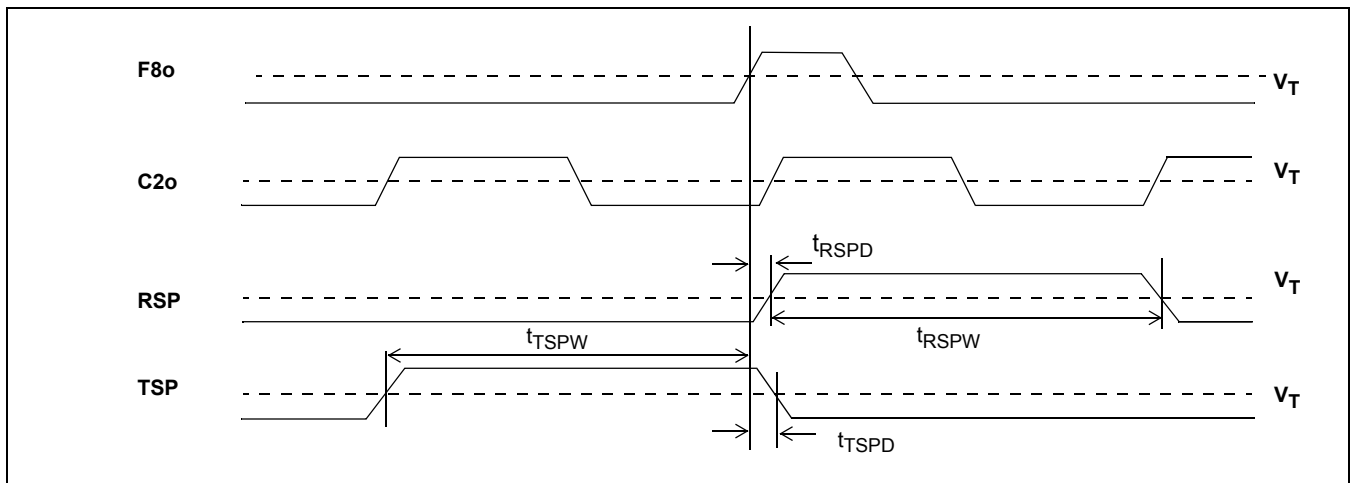


Figure 11 - Output Timing 2

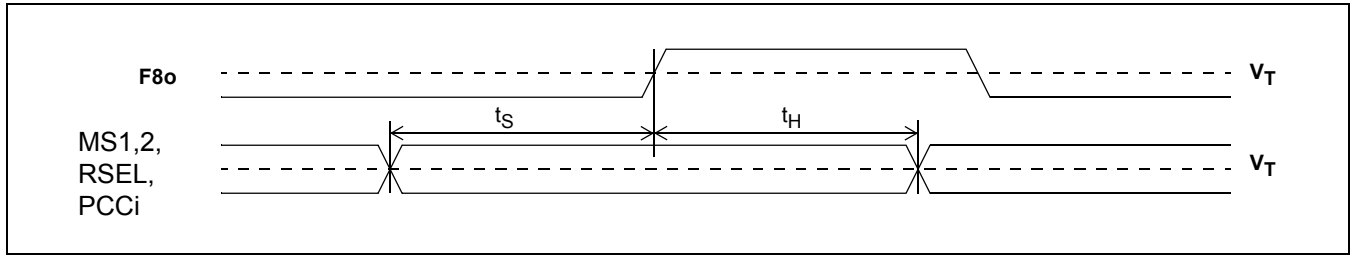


Figure 12 - Input Controls Setup and Hold Timing

AC Electrical Characteristics - Intrinsic Jitter Unfiltered

	Characteristics	Sym.	Max.	Units	Conditions/Notes†
1	Intrinsic jitter at F8o (8 kHz)		0.0002	UIpp	1-12,19-22,26
2	Intrinsic jitter at F0o (8 kHz)		0.0002	UIpp	1-12,19-22,26
3	Intrinsic jitter at F16o (8 kHz)		0.0002	UIpp	1-12,19-22,26
4	Intrinsic jitter at C1.5o (1.544 MHz)		0.030	UIpp	1-12,19-22,27
5	Intrinsic jitter at C2o (2.048 MHz)		0.040	UIpp	1-12,19-22,28
6	Intrinsic jitter at C6o (6.312 MHz)		0.120	UIpp	1-12,19-22,29
7	Intrinsic jitter at C4o (4.096 MHz)		0.080	UIpp	1-12,19-22,30
8	Intrinsic jitter at C8o (8.192 MHz)		0.104	UIpp	1-12,19-22,31
9	Intrinsic jitter at C16o (16.384 MHz)		0.104	UIpp	1-12,19-22,32
10	Intrinsic jitter at TSP (8 kHz)		0.0002	UIpp	1-12,19-22,26
11	Intrinsic jitter at RSP (8 kHz)		0.0002	UIpp	1-12,19-22,26
12	Intrinsic jitter at C19o (19.44 MHz)		0.27	UIpp	1-12,19-22,33

† See "Notes" following AC Electrical Characteristics tables.

AC Electrical Characteristics - C1.5o (1.544 MHz) Intrinsic Jitter Filtered

	Characteristics	Sym.	Min.	Max.	Units	Conditions/Notes†
1	Intrinsic jitter (4 Hz to 100 kHz filter)			0.015	UIpp	1-12,19-22,27
2	Intrinsic jitter (10 Hz to 40 kHz filter)			0.010	UIpp	1-12,19-22,27
3	Intrinsic jitter (8 kHz to 40kHz filter)			0.010	UIpp	1-12,19-22,27
4	Intrinsic jitter (10Hz to 8 kHz filter)			0.005	UIpp	1-12,19-22,27

† See "Notes" following AC Electrical Characteristics tables.

AC Electrical Characteristics - C2o (2.048MHz) Intrinsic Jitter Filtered

	Characteristics	Sym.	Min.	Max.	Units	Conditions/Notes†
1	Intrinsic jitter (4 Hz to 100 kHz filter)			0.015	Upp	1-12,19-22,28
2	Intrinsic jitter (10 Hz to 40 kHz filter)			0.010	Upp	1-12,19-22,28
3	Intrinsic jitter (8 kHz to 40 kHz filter)			0.010	Upp	1-12,19-22,28
4	Intrinsic jitter (10 Hz to 8 kHz filter)			0.005	Upp	1-12,19-22,28

† See "Notes" following AC Electrical Characteristics tables.

AC Electrical Characteristics - 8kHz Input to 8kHz Output Jitter Transfer

	Characteristics	Sym	Min.	Max.	Units	Conditions/Notes†
1	Jitter attenuation for 1 Hz@0.01 Upp input		0	6	dB	1,3,7-12, 19-20, 22, 26, 34
2	Jitter attenuation for 1 Hz@0.54 Upp input		6	16	dB	1,3,7-12, 19-20, 22, 26, 34
3	Jitter attenuation for 10 Hz@0.10 Upp input		12	22	dB	1,3,7-12, 19-20, 22, 26, 34
4	Jitter attenuation for 60 Hz@0.10 Upp input		28	38	dB	1,3,7-12, 19-20, 22, 26, 34
5	Jitter attenuation for 300 Hz@0.10 Upp input		42		dB	1,3,7-12, 19-20, 22, 26, 34
6	Jitter attenuation for 3600 Hz@0.005 Upp input		45		dB	1,3,7-12, 19-20, 22, 26, 34

† See "Notes" following AC Electrical Characteristics tables.

AC Electrical Characteristics - 1.544 MHz Input to 1.544 MHz Output Jitter Transfer

	Characteristics	Sym.	Min.	Max.	Units	Conditions/Notes†
1	Jitter attenuation for 1 Hz@20 Upp input		0	6	dB	1,4,7-12, 19-20,22,27,34
2	Jitter attenuation for 1 Hz@104 Upp input		6	16	dB	1,4,7-12, 19-20,22,27,34
3	Jitter attenuation for 10 Hz@20 Upp input		12	22	dB	1,4,7-12, 19-20,22,27,34
4	Jitter attenuation for 60 Hz@20 Upp input		28	38	dB	1,4,7-12, 19-20,22,27,34
5	Jitter attenuation for 300 Hz@20 Upp input		42		dB	1,4,7-12, 19-20,22,27,34
6	Jitter attenuation for 10 kHz@0.3 Upp input		45		dB	1,4,7-12, 19-20,22,27,34
7	Jitter attenuation for 100 kHz@0.3 Upp input		45		dB	1,4,7-12, 19-20,22,27,34

† See "Notes" following AC Electrical Characteristics tables.

AC Electrical Characteristics - 2.048 MHz Input to 2.048 MHz Output Jitter Transfer

	Characteristics	Sym.	Min.	Max.	Units	Conditions/Notes†
1	Jitter at output for 1 Hz@3.00 Ulpp input			2.9	Ulpp	1,5,7-12,19-20,22,28,34
2	with 40 Hz to 100 kHz filter			0.09	Ulpp	1,5,7-12,19-20,22,28,35
3	Jitter at output for 3 Hz@2.33 Ulpp input			1.3	Ulpp	1,5,7-12,19-20,22,28,34
4	with 40 Hz to 100 kHz filter			0.10	Ulpp	1,5,7-12,19-20,22,28,35
5	Jitter at output for 5 Hz@2.07 Ulpp input			0.80	Ulpp	1,5,7-12,19-20,22,28,34
6	with 40 Hz to 100 kHz filter			0.10	Ulpp	1,5,7-12,19-20,22,28,35
7	Jitter at output for 10 Hz@1.76 Ulpp input			0.40	Ulpp	1,5,7-12,19-20,22,28,34
8	with 40 Hz to 100 kHz filter			0.10	Ulpp	1,5,7-12,19-20,22,28,35
9	Jitter at output for 100 Hz@1.50 Ulpp input			0.06	Ulpp	1,5,7-12,19-20,22,28,34
10	with 40 Hz to 100 kHz filter			0.05	Ulpp	1,5,7-12,19-20,22,28,35
11	Jitter at output for 2400 Hz@1.50 Ulpp input			0.04	Ulpp	1,5,7-12,19-20,22,28,34
12	with 40 Hz to 100 kHz filter			0.03	Ulpp	1,5,7-12,19-20,22,28,35
13	Jitter at output for 100 kHz@0.20 Ulpp input			0.04	Ulpp	1,5,7-12,19-20,22,28,34
14	with 40 Hz to 100 kHz filter			0.02	Ulpp	1,5,7-12,19-20,22,28,33

† See "Notes" following AC Electrical Characteristics tables.

AC Electrical Characteristics - 8 kHz Input Jitter Tolerance

	Characteristics	Sym.	Min.	Max.	Units	Conditions/Notes†
1	Jitter tolerance for 1 Hz input		0.80		U _{Ipp}	1,3,7 -12,19-20,22-24,26
2	Jitter tolerance for 5 Hz input		0.70		U _{Ipp}	1,3,7 -12,19-20,22-24,26
3	Jitter tolerance for 20 Hz input		0.60		U _{Ipp}	1,3,7 -12,19-20,22-24,26
4	Jitter tolerance for 300 Hz input		0.20		U _{Ipp}	1,3,7 -12,19-20,22-24,26
5	Jitter tolerance for 400 Hz input		0.15		U _{Ipp}	1,3,7 -12,19-20,22-24,26
6	Jitter tolerance for 700 Hz input		0.08		U _{Ipp}	1,3,7 -12,19-20,22-24,26
7	Jitter tolerance for 2400 Hz input		0.02		U _{Ipp}	1,3,7 -12,19-20,22-24,26
8	Jitter tolerance for 3600 Hz input		0.01		U _{Ipp}	1,3,7 -12,19-20,22-24,26

† See "Notes" following AC Electrical Characteristics tables.

AC Electrical Characteristics - 1.544 MHz Input Jitter Tolerance

	Characteristics	Sym.	Min.	Max.	Units	Conditions/Notes†
1	Jitter tolerance for 1 Hz input		150		U _{Ipp}	1,4,7-12,19-20,22-24,27
2	Jitter tolerance for 5 Hz input		140		U _{Ipp}	1,4,7-12,19-20,22-24,27
3	Jitter tolerance for 20 Hz input		130		U _{Ipp}	1,4,7-12,19-20,22-24,27
4	Jitter tolerance for 300 Hz input		35		U _{Ipp}	1,4,7-12,19-20,22-24,27
5	Jitter tolerance for 400 Hz input		25		U _{Ipp}	1,4,7-12,19-20,22-24,27
6	Jitter tolerance for 700 Hz input		15		U _{Ipp}	1,4,7-12,19-20,22-24,27
7	Jitter tolerance for 2400 Hz input		4		U _{Ipp}	1,4,7-12,19-20,22-24,27
8	Jitter tolerance for 10 kHz input		1		U _{Ipp}	1,4,7-12,19-20,22-24,27
9	Jitter tolerance for 100 kHz input		0.5		U _{Ipp}	1,4,7-12,19-20,22-24,27

† See "Notes" following AC Electrical Characteristics tables.

AC Electrical Characteristics - 2.048 MHz Input Jitter Tolerance

	Characteristics	Sym.	Min.	Max.	Units	Conditions/Notes†
1	Jitter tolerance for 1 Hz input		150		UIpp	1,5,7 -12,19-20,22-24,28
2	Jitter tolerance for 5 Hz input		140		UIpp	1,5,7 -12,19-20,22-24,28
3	Jitter tolerance for 20 Hz input		130		UIpp	1,5,7 -12,19-20,22-24,28
4	Jitter tolerance for 300 Hz input		50		UIpp	1,5,7 -12,19-20,22-24,28
5	Jitter tolerance for 400 Hz input		40		UIpp	1,5,7 -12,19-20,22-24,28
6	Jitter tolerance for 700 Hz input		20		UIpp	1,5,7 -12,19-20,22-24,28
7	Jitter tolerance for 2400 Hz input		5		UIpp	1,5,7 -12,19-20,22-24,28
8	Jitter tolerance for 10 kHz input		1		UIpp	1,5,7 -12,19-20,22-24,28
9	Jitter tolerance for 100 kHz input		1		UIpp	1,5,7 -12,19-20,22-24,28

† See "Notes" following AC Electrical Characteristics tables.

AC Electrical Characteristics - OSCi 20 MHz Master Clock Input

	Characteristics	Sym.	Min.	Max.	Units	Conditions/Notes†
1	Tolerance		-0	+0	ppm	13,16
2			-32	+32	ppm	14,17
3			-100	+100	ppm	15,18
4	Duty cycle		40	60	%	
5	Rise time			10	ns	
6	Fall time			10	ns	

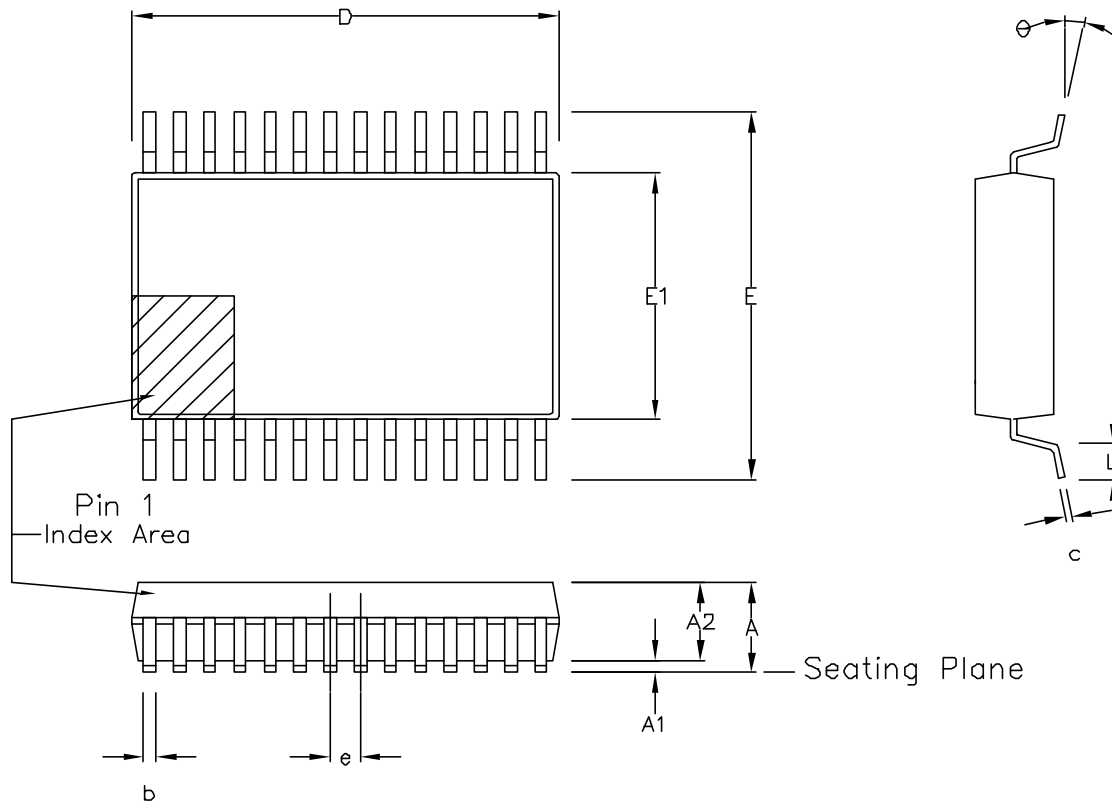
† See "Notes" following AC Electrical Characteristics tables.

† Notes:

Voltages are with respect to ground (V_{SS}) unless otherwise stated.
 Supply voltage and operating temperature are as per Recommended Operating Conditions.
 Timing parameters are as per AC Electrical Characteristics - Timing Parameter Measurement Voltage Levels

1. Normal Mode selected.
2. Freerun Mode selected.
3. 8 kHz Frequency Mode selected.
4. 1.544 MHz Frequency Mode selected.
5. 2.048 MHz Frequency Mode selected.
6. 19.44 MHz Frequency Mode selected.
7. Master clock input OSCi at 20 MHz ± 0 ppm.
8. Master clock input OSCi at 20 MHz ± 32 ppm.
9. Master clock input OSCi at 20 MHz ± 100 ppm.
10. Reference input at ± 0 ppm.
11. Reference input at ± 32 ppm.
12. Reference input at ± 100 ppm.
13. For Freerun Mode of ± 0 ppm.
14. For Freerun Mode of ± 32 ppm.
15. For Freerun Mode of ± 100 ppm.
16. For capture range of ± 230 ppm.
17. For capture range of ± 198 ppm.
18. For capture range of ± 130 ppm.
19. 25 pF capacitive load.
20. OSCi Master Clock jitter is less than 2 nspp, or 0.04UIpp where 1 UIpp=1/20 MHz.
21. Jitter on reference input is less than 7 nspp.

-
- 22. Applied jitter is sinusoidal.
 - 23. Minimum applied input jitter magnitude to regain synchronization.
 - 24. Loss of synchronization is obtained at slightly higher input jitter amplitudes.
 - 25. Within 10 ms of the state, reference or input change.
 - 26. 1 Ulpp = 125 us for 8 kHz signals.
 - 27. 1 Ulpp = 648 ns for 1.544 MHz signals.
 - 28. 1 Ulpp = 488 ns for 2.048 MHz signals.
 - 29. 1 Ulpp = 158 ns for 6.312 MHz signals.
 - 30. 1 Ulpp = 244 ns for 4.096 MHz signals.
 - 31. 1 Ulpp = 122 ns for 8.192 MHz signals.
 - 32. 1 Ulpp = 61 ns for 16.384 MHz signals.
 - 33. 1 Ulpp = 51.44 ns for 19.44 MHz signals.
 - 34. No filter.
 - 35. 40 Hz to 100 kHz bandpass filter.
 - 36. With respect to reference input signal frequency.
 - 37. After a RST.
 - 38. Master clock duty cycle 40% to 60%.



Symbol	Control Dimensions in millimetres				Altern. Dimensions in inches		
	MIN	Nominal	MAX		MIN	Nominal	MAX
A	2.41	2.59	2.79		0.095	0.102	0.110
A1	0.20	0.30	0.40		0.008	0.012	0.016
A2	2.26	2.39	2.52		0.089	0.094	0.099
D	15.75	15.88	16.00		0.620	0.625	0.630
E	10.03	10.31	10.67		0.395	0.406	0.420
E1	7.39	7.49	7.59		0.291	0.295	0.299
L	0.51	0.76	1.02		0.020	0.030	0.040
e	0.64 BSC.				0.025 BSC.		
b	0.20	0.25	0.34		0.008	0.010	0.0135
c	0.13	0.20	0.25		0.005	0.008	0.010
θ	0°		8°		0°		8°
	Pin features						
N	48						
Conforms to JEDEC					MO-118 AA Iss. A		

Notes:

1. A visual index feature, e.g. a dot, must be located within the cross-hatched area.
2. Controlling dimension are in millimeters.
3. Dimensions D and E1 do not include mould flash or protrusion. Mould flash or protrusion shall not exceed 0.15 mm per side. D and E1 are maximum plastic body size dimensions including mould mismatch.

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Previous package codes

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Package Code DD

Package Outline for 48 lead
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